

SPEAR-09-H042

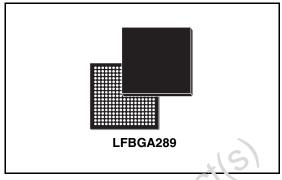
SPEAr™ Head200

ARM 926, 200 K customizable eASIC™ gates, large IP portfolio SoC

Data Brief

Features

- ARM926EJ-S f_{MAX} 266 MHz, 32 KI - 16 KD cache, 8 KI - KD TCM, ETM9 and JTAG interfaces
- 200K customizable equivalent ASIC gates (16K LUT equivalent) with 8 channels internal DMA high speed accelerator function and 87 dedicated general purpose I/Os
- Multilayer AMBA 2.0 compliant bus with f_{MAX} 133 MHz
- Programmable internal clock generator with enhanced PLL function, specially optimized for E.M.I. reduction
- 16 KB single port SRAM embedded
- Dynamic RAM interface: 8/16 bit DDR, 8/16 bit SDRAM
- SPI interface connecting serial ROM and Flash devices
- 2 USB 2.0 Host independent ports with integrated PHYs
- USB 2.0 device with integrated PHY
- Ethernet MAC 10/100 with MII management interface
- 1 independent UART up to 115 Kbps (software flow control mode)
- I²C master mode fast and slow speed
- 6 general purpose I/Os



- Real time clock
- WatchDog
- 4 general purpose timers
- Operating temperature: 40 to 85 °C
- Package: LF3GA289 (15x15x1.7mm pitch 0.8mm)

Description

SPEAr Head200 is a powerful digital engine belonging to SPEAr family, the innovative customizable system-on-chip.

The device integrates an ARM core with a large set of proven IPs (Intellectual Properties) and a configurable logic block that allows very fast customization of unique and/or proprietary solutions, with low effort and low investment.

Optimized for embedded applications.

Table 1. Device summary

Order code	Package	Packing
SPEAR-09-H042	LFBGA289 (15x15x1.7mm)	Tray

January 2008 Rev 1 1/16

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SPEAR-09-H042 Introduction

1 Introduction

This data brief describes the differences between SPEAr Head200 (SPEAR-09-H022) and the one packaged in LFBGA289 balls 0.8mm pitch (SPEAR-09-H042).

In this document the main package characteristics are described as well as the chip features modifications.

The reference specifications, for the SPEAR-09-H022 are available on the web at: www.st.com.



Features modification SPEAR-09-H042

2 Features modification

To fit the new small package a number of features has been reduced or limited:

- Analog to digital converter (ADC)
- eASIC GPIOs
- External FPGA emulation mode
- Dynamic RAM data path
- UARTs

2.1 Analog to digital converter (ADC)

ADC feature has been completely deleted so the 16 analog channels, the related test output, the power balls and the reference voltages have been removed.

2.2 eASIC GPIOs

SPEAR-09-H022 features 112 GPIOs in the eASIC customizable part, some of these I/Os have been removed, but 87 are still available on SPEAR-09-H042.

Unusable hidden eASIC GPIOs (74, 76, 78, 80, 82, 84, 86, 88, 90, 92, 94, 96, 98, 100-111) must be configured as inputs.

2.3 External FPGA emulation mode

SPEAR-09-H022 has the capability to emulate the internal eASIC behavior with an external FPGA through the component GPIOs. This feature has been completely removed on SPEAR-09-H042 hence the development boards must use the 420 PBGA components.

2.4 Dynamic RAM data path

The SPEAr component features a multi purpose memory controller to interface SDRAM or DDR memories able to work with different data path widths.

While SPEAR-09-H022 handles 8 and 16-bit DDRs or 8, 16 and 32-bit SDRAMs, on SPEAR-09-H042 to save 16 data balls and the related "data mask" balls, the SDRAM data path has been limited to 16-bit like the DDR one.

2.5 UARTs

Two of the original UART interfaces have been removed, SPEAR-09-H042 features just the UART1 interface.

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3 Pin description

Table 2 shows the component signals, grouped by function, and the relative ballout diagram.

3.1 Interface signals

Table 2. Interface signals

Group	Signal Name	Ball	Direction	Function
	TEST0	A14		
	TEST1	H14		
Debug	TEST2	H13	Input	Test configuration port. For the functional mode they have to be set to 0
	TEST3	H12		16
	PLL_BYPASS	G1	Input	Enable / disable PLL bypass
eASIC	eASICGP_IO[00]	G4	I/O	eASIC general purpose I/O
	eASICGP_IO[01]	H7		00.0
	eASICGP_IO[02]	H6		010
	eASICGP_IO[03]	H5	× (2
	eASICGP_IO[04]	F3	16/	
	eASICGP_IO[05]	E4	CO,	
	eASICGP_IO[06]	F5		
	eASICGP_IO[07]	D2		
	eASICGP_IO[08]	E3		
	eASICGP_IO[09]	D3		
	eASICGP_IO[10]	D1		
	eASICGP_IO[11]	G6		
01	eASICGP_IO[12]	G7		
x6,	eASICGP_IO[13]	D4		
	eASICGP_IO[14]	C1		
	eASICGP_IO[15]	E5		
	eASICGP_IO[16]	F6		
	eASICGP_IO[17]	B1		
	eASICGP_IO[18]	E6		
	eASICGP_IO[19]	B4		
	eASICGP_IO[20]	F7		
	eASICGP_IO[21]	A1		

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Table 2. Interface signals (continued)

Group	Signal Name	Ball	Direction	Function
	eASICGP_IO[22]	А3		
	eASICGP_IO[23]	A4		
	eASICGP_IO[24]	C2		
	eASICGP_IO[25]	F4		
	eASICGP_IO[26]	СЗ		
	eASICGP_IO[27]	C5		
	eASICGP_IO[28]	B5		
	eASICGP_IO[29]	H8		
	eASICGP_IO[30]	B2		
	eASICGP_IO[31]	G5		
	eASICGP_IO[32]	В3		
	eASICGP_IO[33]	A2		4(5)
	eASICGP_IO[34]	C4		IC!
	eASICGP_IO[35]	A5		20/0,
	eASICGP_IO[36]	H9		010
	eASICGP_IO[37]	C6	. (
	eASICGP_IO[38]	G9	10.1	
	eASICGP_IO[39]	C7	~O/O	e Product(s)
	eASICGP_IO[40]	D5	25	
	eASICGP_IO[41]	B6		
	eASICGP_IO[42]	A6		
	eASICGP_IO[43]	G8		
	eASICGP_IO[44]	E8		
	eASICGP_IO[45]	E9		
01	eASICGP_IO[46]	D8		
.0.	eASICGP_IO[47]	В7		
	eASICGP_IO[48]	E7		
	eASICGP_IO[49]	F8		
	eASICGP_IO[50]	A7		
	eASICGP_IO[51]	B8		
	eASICGP_IO[52]	A8		
	eASICGP_IO[53]	D9		
	eASICGP_IO[54]	D6		
	eASICGP_IO[55]	F9		
	eASICGP_IO[56]	D7		

Table 2. Interface signals (continued)

Group	Signal Name	Ball	Direction	Function
	eASICGP_IO[57]	F10		
	eASICGP_IO[58]	C9		
	eASICGP_IO[59]	В9		
	eASICGP_IO[60]	A9		
	eASICGP_IO[61]	G10		
	eASICGP_IO[62]	C8		
	eASICGP_IO[63]	E10		
	eASICGP_IO[64]	D10		
	eASICGP_IO[65]	C10		
	eASICGP_IO[66]	B10		
	eASICGP_IO[67]	A10		
	eASICGP_IO[68]	G11		,(5)
	eASICGP_IO[69]	F11		IC/
	eASICGP_IO[70]	E11		90,0
	eASICGP_IO[71]	D11		010
	eASICGP_IO[72]	C11	. (
	eASICGP_IO[73-74]	B11	101	
	eASICGP_IO[75-76]	A11	~O/O	e Product(s)
	eASICGP_IO[77-78]	A12	75	
	eASICGP_IO[79-80]	B12		
	eASICGP_IO[81-82]	C12		
	eASICGP_IO[83-84]	D12		
	eASICGP_IO[85-86]	E12		
	eASICGP_IO[87-88]	A13		
01	eASICGP_IO[89-90]	B13		
W.C. Y	eASICGP_IO[91-92]	C13		
	eASICGP_IO[93-94]	D13		
	eASICGP_IO[95-96]	E13		
	eASICGP_IO[97-98]	C14		
	eASICGP_IO[99]	D14		
	eASIC_EXT_CLOCK	E14		
	eASIC_PI_CLOCK	K15		eASIC program interface out clock
Ethernet	TX_CLK	C15	Input	Ethernet input TX clock
	TXD[0]	C16		Ethernet TX output data
	TXD[1]	C17		Ethernet TX output data

Pin description SPEAR-09-H042

Table 2. Interface signals (continued)

Group Signal Name Ball Direction Function TXD[2] D15 Output Ethernet TX output data Ethernet TX output data Ethernet TX output data Ethernet TX enable TX_EN D17 Ethernet TX enable CRS E15 Input Carrier sense input COL E16 Collision detection input RX_CLK E17 Input Ethernet input RX clock RXD[0] F15 Input Ethernet RX input data RXD[1] F16 Input Data valid on RX RX_D[2] F17 Input Data valid on RX RX_D[3] G15 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	a a a a a a a a a a a a a a a a a a a
TXD[3] D16 TX_EN D17 CRS E15 Input Carrier sense input COL E16 RX_CLK E17 Input Ethernet input RX clock RXD[0] F15 RXD[1] F16 Input Ethernet RX input data RXD[2] F17 RXD[3] G15 RX_DV G16 Input Data valid on RX RX_ER G17 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	ut k
TX_EN D17 CRS E15 Input Carrier sense input COL E16 Collision detection input RX_CLK E17 Input Ethernet input RX clock RXD[0] F15 RXD[1] F16 Input Ethernet RX input data RXD[2] F17 RXD[3] G15 RX_DV G16 Input Data valid on RX RX_ER G17 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	ut k
CRS E15 Input Carrier sense input COL E16 Collision detection input RX_CLK E17 Input Ethernet input RX clock RXD[0] F15 RXD[1] F16 Input Ethernet RX input data RXD[2] F17 RXD[3] G15 RX_DV G16 Input Data valid on RX RX_ER G17 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	k
COL E16 Collision detection input RX_CLK E17 Input Ethernet input RX clock RXD[0] F15 RXD[1] F16 Input Ethernet RX input data RXD[2] F17 RXD[3] G15 RX_DV G16 Input Data valid on RX RX_ER G17 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	k
RX_CLK E17 Input Ethernet input RX clock RXD[0] F15 RXD[1] F16 Input Ethernet RX input data RXD[2] F17 RXD[3] G15 RX_DV G16 Input Data valid on RX RX_ER G17 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	k
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RXD[2] F17 RXD[3] G15 RX_DV G16 Input Data valid on RX RX_ER G17 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	(6)
RXD[3] G15 RX_DV G16 Input Data valid on RX RX_ER G17 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	(5)
RX_DV G16 Input Data valid on RX RX_ER G17 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	(9)
RX_ER G17 Input Data error detected MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	(6)
MDC H15 Output Output timing reference MDIO H16 I/O I/O data to PHY	5
MDIO H16 I/O I/O data to PHY	. C P.4D10
	e for MDIO
OD IOIOI MAS	
GP_IO[0] M15	
GP_IO[1] L17	
GPI/Os GP_IO[2] L16 I/O General purpose I/O	
GP_IO[3] L15	
GP_IO[4] K17	
GP_IO[5] K16	
I2C SDA H17 I/O I2C serial data	
SCL J15 Output I2C clock	
TDO F12 Output JTAG TDO	
TDI F13 Input JTAG TDI	
JTAG TMS F14 Input JTAG TMS	
RTCK G12 Output JTAG output clock	
TCK G13 Input JTAG clock	
nTRST G14 Output JTAG reset	
Master MCLK_in N1 Input 12MHz input crystal	
clock MCLK_out N2 Output 12MHz output crystal	
Master reset MRESET G3 Input Master reset	
MPMC MPMCDATA[00] T12	
MPMCDATA[01] R12	
MPMCDATA[02] T13	
MPMCDATA[03] R13	

Table 2. Interface signals (continued)

Group Signal Name Ball Direction Function		Signal Name		r e	Franchica
MPMCDATA[05] R14 MPMCDATA[06] T15 MPMCDATA[07] R15 MPMCDATA[08] T17 MPMCDATA[09] P16 MPMCDATA[10] P17 MPMCDATA[11] N15 MPMCDATA[12] N16 MPMCDATA[13] N17 MPMCADTA[14] M16 MPMCADDROUT[00] R6 MPMCADDROUT[01] U7 MPMCADDROUT[02] T7 MPMCADDROUT[03] R7 MPMCADDROUT[04] U8 MPMCADDROUT[05] T8 MPMCADDROUT[06] R8 MPMCADDROUT[07] U9 MPMCADDROUT[08] T9 MPMCADDROUT[10] U10 MPMCADDROUT[10] U10 MPMCADDROUT[11] T10 MPMCADDROUT[12] R10 MPMCADDROUT[13] T11 MPMCADDROUT[14] R11 nMPMCDYCSOUT[1] T4 nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[2] T5 nMPMCCKEOUT[0]	Group	Signal Name	Ball	Direction	Function
MPMCDATA[06] T15					
MPMCDATA[07]			R14		
MPMCDATA[08] T17 MPMCDATA[09] P16 MPMCDATA[10] P17 MPMCDATA[11] N15 MPMCDATA[12] N16 MPMCDATA[13] N17 MPMCDATA[14] M16 MPMCDATA[15] M17 MPMCDATA[15] M17 MPMCDATA[15] M17 MPMCADROUT[0] R6 MPMCADROUT[0] T7 MPMCADDROUT[03] R7 MPMCADDROUT[04] U8 MPMCADDROUT[05] T8 MPMCADDROUT[06] R8 MPMCADDROUT[07] U9 MPMCADDROUT[08] T9 MPMCADDROUT[08] T9 MPMCADDROUT[10] U10 MPMCADDROUT[11] T10 MPMCADDROUT[12] R10 MPMCADDROUT[13] T11 MPMCADDROUT[14] R11 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 nMPMCDYCSOUT[2] T5 nMPMCCKEOUT[0] U11 Output MPMCCKEOUT[0] U12 MPMCCKEOUT[1] U12 MPMCCKEOUT[1] U12 MPMCCKEOUT[1] U12 MPMCCKEOUT[1] U16 MPMCCKEOU		MPMCDATA[06]	T15		
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MPMCADDROUT[04] U8		MPMCADDROUT[02]	T7		010
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MPMCADDROUT[07] U9 Output DDR / SDRAM address MPMCADDROUT[08] T9 MPMCADDROUT[109] R9 MPMCADDROUT[10] U10 MPMCADDROUT[11] T10 MPMCADDROUT[12] R10 MPMCADDROUT[13] T11 MPMCADDROUT[14] R11 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 Output DDR / SDRAM chip select nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 DDR / SDRAM clock 1		MPMCADDROUT[05]	T8	~O/O	
MPMCADDROUT[08] T9 MPMCADDROUT[10] U10 MPMCADDROUT[11] T10 MPMCADDROUT[12] R10 MPMCADDROUT[13] T11 MPMCADDROUT[14] R11 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 Output DDR / SDRAM chip select nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 DDR / SDRAM clock 1		MPMCADDROUT[06]	R8	75	
MPMCADDROUT[09] R9 MPMCADDROUT[10] U10 MPMCADDROUT[11] T10 MPMCADDROUT[12] R10 MPMCADDROUT[13] T11 MPMCADDROUT[14] R11 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 Output DDR / SDRAM chip select nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 DDR / SDRAM clock 1		MPMCADDROUT[07]	U9	Output	DDR / SDRAM address
MPMCADDROUT[10] U10 MPMCADDROUT[11] T10 MPMCADDROUT[12] R10 MPMCADDROUT[13] T11 MPMCADDROUT[14] R11 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 DDR / SDRAM clock 1		MPMCADDROUT[08]	T9		
MPMCADDROUT[11] T10 MPMCADDROUT[12] R10 MPMCADDROUT[13] T11 MPMCADDROUT[14] R11 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 MPMCCKEOUT[1] U12 MPMCCKEOUT[1] U12 MPMCCLKOUT[0] U16 DDR / SDRAM clock enable		MPMCADDROUT[09]	R9		
MPMCADDROUT[12] R10 MPMCADDROUT[13] T11 MPMCADDROUT[14] R11 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 Output DDR / SDRAM chip select nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 DDR / SDRAM clock 1		MPMCADDROUT[10]	U10		
MPMCADDROUT[13] T11 MPMCADDROUT[14] R11 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 DDR / SDRAM clock 1		MPMCADDROUT[11]	T10		
MPMCADDROUT[14] R11 nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 MPMCCKEOUT[1] U12 MPMCCKEOUT[1] U12 MPMCCLKOUT[0] U16 DDR / SDRAM clock 1	01	MPMCADDROUT[12]	R10		
nMPMCDYCSOUT[0] U4 nMPMCDYCSOUT[1] T4 Output DDR / SDRAM chip select nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 DDR / SDRAM clock 1	NO. Y	MPMCADDROUT[13]	T11		
nMPMCDYCSOUT[1] T4 Output DDR / SDRAM chip select nMPMCDYCSOUT[2] T5 DDR / SDRAM chip select nMPMCDYCSOUT[3] R5 DDR / SDRAM clock enable MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 DDR / SDRAM clock 1	10	MPMCADDROUT[14]	R11		
nMPMCDYCSOUT[2] T5 nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 MPMCCLKOUT[0] U16 DDR / SDRAM clock 1		nMPMCDYCSOUT[0]	U4		
nMPMCDYCSOUT[3] R5 MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 MPMCCLKOUT[0] U16 DDR / SDRAM clock 1		nMPMCDYCSOUT[1]	T4	Output	DDR / SDRAM chip select
MPMCCKEOUT[0] U11 Output DDR / SDRAM clock enable MPMCCKEOUT[1] U12 MPMCCLKOUT[0] U16 DDR / SDRAM clock 1		nMPMCDYCSOUT[2]	T5		
MPMCCKEOUT[1] U12 MPMCCLKOUT[0] U16 DDR / SDRAM clock 1		nMPMCDYCSOUT[3]	R5		
MPMCCLKOUT[0] U16 DDR / SDRAM clock 1		MPMCCKEOUT[0]	U11	Output	DDR / SDRAM clock enable
		MPMCCKEOUT[1]	U12		
nMPMCCLKOUT[0] U15 Output DDR / SDRAM clock 1 neg.		MPMCCLKOUT[0]	U16		DDR / SDRAM clock 1
		nMPMCCLKOUT[0]	U15	Output	DDR / SDRAM clock 1 neg.

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Table 2. Interface signals (continued)

Group	up Signal Name		Direction	Function
	MPMCCLKOUT[1]	U14		DDR / SDRAM clock 2
	nMPMCCLKOUT[1]	U13		DDR / SDRAM clock 2 neg.
	MPMCDQMOUT[0]	T16	Outout	DDD / CDDAM data mask
	MPMCDQMOUT[1]	U17	Output	DDR / SDRAM data mask
	MPMCDQS[0]	R16	Outrot	DDD data atrialia
	MPMCDQS[1]	R17	Output	DDR data strobe
	nMPMCCASOUT	T6	Output	DDD / CDDAM strokes
	nMPMCRASOUT	U6	Output	DDR / SDRAM strobes
	nMPMCWEOUT	U5	Output	DDR / SDRAM write enable
RTC	RTCXO	U2	Output	32.768KHx output crystal
	RTCXI	U1	Input	32.768KHz input crystal
	SMINCS[0]	B15		,(5)
	SMINCS[1]	A17	Output	Serial flash chip select
	SMINCS[2]	A16		
SMI	SMINCS[3]	A15		0100
	SMICLK	B16	Output	Serial flash output clock
	SMIDATAIN	B17	Input	Serial flash data in
	SMIDATAOUT	B14	Output	Serial flash data out
UART	UART1_RXD	J17	Input	UART1 RX data
UART	UART1_TXD	J16	Output	UART1 TX data
	DMNS	R2	I/O	D- port of USB device
	DPLS	R1	I/O	D+ port of USB device
	HOST1_DP	L1	I/O	D+ port of USB host1
	HOST1_DM	L2	I/O	D- port of USB host1
0	HOST2_DP	J1	I/O	D+ port of USB host2
NO. Y	HOST2_DM	J2	I/O	D- port of USB host2
USBs	HOST1_VBUS	F1	Output	USB host1 VBUS signal
	HOST2_VBUS	F2	Output	USB host2 VBUS signal
	OVERCURH1	E1	I/O	USB host1overcurrent
USBs	OVERCURH2	E2	I/O	USB host2 overcurrent
	VBUS	G2	I/O	USB device VBUS signal
	RREF	J6	Input	USB reference resistor

3.2 Power connections

Table 3. Power connections

Group	Signal Name	Ball	Function
	vdd3v3	(1)	Digital 3.3V power
	vdd	(2)	Digital 1.2V power
	gnd	(3)	Digital ground
	vdd_dith	P6	DDR / SDR dedicated digital PLL 3.3V power
	vss_dith	P7	DDR / SDR dedicated digital PLL ground
	SSTL_VREF	P15	Voltage reference SSTL / CMOS mode. This pin is used both as logic state and as power supply
	vdd2v5_DDR	(4)	DDR / SDR digital 2.5V / 3.3V power
	vdd1v2_date_osci	T1	1.2V dedicated power for RTC
	vdd_date_osci	U3	1.2V dedicated power for RTC
	gnd_date_osci	Т3	Dedicated digital ground for RTC
	gnde_date_osci	T2	Dedicated digital ground for RTC
	anavdd_3v3_pll1600	M3	Dedicated USB PLL analog 3.3V power
	anagnd_3v3_pll1600	M4	Dedicated USB PLL analog ground
	digvdd_1v2_pll1600	N3	Dedicated USB PLL analog 1.2V power
	diggnd_1v2_pll1600	N4	Dedicated USB PLL analog ground
	vddl_1v2_d	P5	Dedicated USB 1.2V power
	vddb_1v2_d	P2	Dedicated USB 1.2V power
Power	vddc_1v2_d	P1	Dedicated USB 1.2V power
	vdd_usb	M5	Dedicated USB 1.2V power
	vddc_1v2_h1	L4	Dedicated USB 1.2V power
	vddb_1v2_h1	L3	Dedicated USB 1.2V power
- 46	vddl_1v2_h1	K3	Dedicated USB 1.2V power
01	vddc_1v2_h0	J5	Dedicated USB 1.2V power
×6,	vddb_1v2_h0	J4	Dedicated USB 1.2V power
	vddl_1v2_h0	НЗ	Dedicated USB 1.2V power
	vdd3_3v3_d	R3	Dedicated USB 3.3V power
	vdde3v3_usb	M2	Dedicated USB 3.3V power
	vdd3_3v3_h1	K2	Dedicated USB 3.3V power
	vdd3_3v3_h0	H2	Dedicated USB 3.3V power
	vssl_3v3_d	R4	Dedicated USB ground
	vssb_1v2_d	P4	Dedicated USB ground
	vssc_1v2_d	P3	Dedicated USB ground

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Table 3. Power connections (continued)

Group	Signal Name	Ball	Function
	gnde_usb	M1	Dedicated USB ground
	gnd_usb	L5	Dedicated USB ground
	vssc_1v2_h1	K5	Dedicated USB ground
	vssb_1v2_h1	K4	Dedicated USB ground
	vssb_1v2_h0	H4	Dedicated USB ground
	vssc_1v2_h0	J3	Dedicated USB ground
	vssl_3v3_h0	H1	Dedicated USB ground
	vssl_3v3_h1	K1	Dedicated USB ground

- 1. Signal spread on the following balls: H11, J08, J09, J13, J14, K14, M14, N14, P14.
- 2. Signal spread on the following balls: H10, J07, J12, L14, N05, P09, P13.
- obsolete Product(s). Obsolete Product(s)

3.3 Ballout top view

Figure 1. Ballout top view

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	
4		eASICG P_IO[33												TEST0	SM INC S[3]	SMINC S[2]	SM INC S[1]	4
3		eASICG P_IO[30												SM ID A TAOUT	SM INC S[0]	SM ICL K	SM ID A TA IN	ا ا
		eASICG P_IO[24														TXD[0]	TXD[1]	(
)	eASICG P_IO[10	eASICG	eASICG P_IO[9]	D IO[13		eASICG P_IO[54									TXD[2]	TXD[3]	TX_EN	
	OVERC URH1	OVERC URH2	eASICG P_IO[8]	e A SIC G		eASICG P_IO[18]									CRS	COL	RX_CL K	
	HOST1_ VBUS	HOST2 _VBUS	eASICG P_IO[4]		eASICG P_IO[6]			eASICG P_IO[49]				TDO	TDI	TMS	RXD[0]	RXD[1]	RXD[2])
à	PLL_B YPASS	VBUS	MRESE T	eASICG P_IO[0]		eASICG P_IO[11		eASICG P_IO[43					тск	nTRST	RXD[3]	RX_DV	RX_ER	
+	vssl_3v 3_h0	vdd3_3 v3_h0	vddl_1v 2_h0			eASICG P_IO[2]			eASICG P_IO[36]	vdd	vdd3v3	TEST3	TEST2	TEST1	MDC	MDIO	SDA	
J	HOST2 _DP	HOST2 _DM	vssc_1v 2_h0	vddb_1v 2_h0	vddc_1v 2_h0	RREF	vdd	vdd3v3	vdd3v3	gnd	gnd	vdd	vdd3v3	vdd3v3	SCL	UART1_ TXD	UART1 _. RXD	
(vssl_3v 3_h1	vdd3_3 v3_h1	vddl_1v 2_h1	vssb_1v 2_h1	vssc_1v 2_h1	gnd	gnd	gnd	gnd	gnd	gnd	gnd	gnd	vdd3v3	eASIC_ PI_CLO CK	GP_IO[5]	GP_IO[4]	
-	HOST1_ DP	HOST1_ DM	vddb_1v 2_h1	vddc_1v 2_h1	gnd_us b	gnd	gnd	gnd	gnd	gnd	gnd	gnd	gnd	vdd	GP_IO[3]	GP_IO[2]	GP_I0[]	
1	gnde_u sb	vdde3v 3_usb	anavdd _3v3_pl 1600	anagnd _3v3_pl 1600	vdd_us b	gnd	gnd	gnd	gnd	gnd	gnd	gnd	gnd	vdd3v3	GP_IO[0]	MPMC DATA[1 4]	MPMC DATA[1 5]	
7	M C L K_i	M C L K_ o ut	digvdd_ 1v2_pll1 600	diggnd_ 1v2_pll1 600	vdd	vdd2v5	vdd2v5	gnd	gnd	gnd	gnd	gnd	gnd	vdd3v3	MPMC DATA[1 1]	MPMC DATA[1 2]		
>	vddc_1v 2_d	vddb_1v 2_d	vssc_1v 2_d	vssb_1v 2_d	vddl_1v 2_d	vdd_dit h	vss_dit h	vdd2v5	vdd	vdd2v5	vdd2v5	vdd2v5	vdd	vdd3v3	SSTL_V REF		MPMC DATA[1 0]	
٦	DPLS	DMNS	vdd3_3 v3_d	vssl_3v 3_d		MPMC ADDR OUT[0]		ADDR		ADDR	ADDR	MPMC DATA[1]					MPMC DQS[1]	
Г	vdd1v2_ date_os ci	gnde_d ate_osc i	gnd_dat e_osci	nMPM CDYCS OUT[1]		nMPM CCASO UT			ADDR		ADDR	DATA[MPMC DATA[6]			
J	RTCXI	RTCXO	vdd_dat e_osci	nMPM CDYCS OUT[0]	nM P M CWEOU T	nMPM CRASO UT	MPMC ADDR OUT[1]	ADDR		ADDR	CKEOU	MPMC CKEOU T[1]		MPMC CLKOU T[1]		MPMC CLKOU T[0]	MPMC DQMO UT[1]	

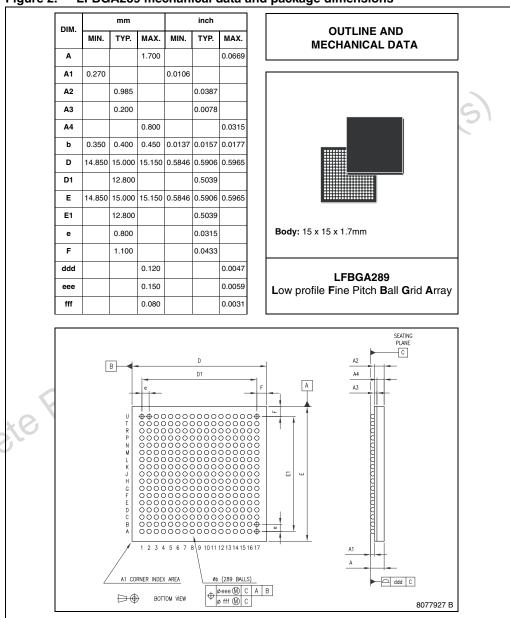
Package information SPEAR-09-H042

4 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Figure 2. LFBGA289 mechanical data and package dimensions



SPEAR-09-H042 Revision history

5 Revision history

Table 4. Document revision history

Date	Revision	Changes
31-Jan-2008	1	Initial release.



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